

ZXTP19020DG 20V PNP high gain transistor in SOT223

Summary

BV_{CEO} > -20V BV_{ECO} > -4V I_{C(cont)} = 8A V_{CE(sat)} < -47mV @ -1A R_{CE(sat)} = 28mΩ P_D = 3.0W



Description

Packaged in the SOT223 outline this new low saturation PNP transistor offers extremely low on state losses making it ideal for use in DC-DC circuits and various driving and power management functions.

Features

Higher power dissipation SOT223 package

Complementary part number ZXTN19020DG

- High gain
- High peak current
- Low saturation voltages
- 4V reverse blocking voltage

Applications

- · Power disconnect switch
- · High side drivers
- Motor drive

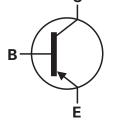
Ordering information

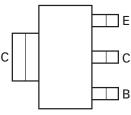
| Device | Reel size | Tape width | Quantity |
|---------------|-----------|------------|----------|
| | (inches) | (mm) | per reel |
| ZXTP19020DGTA | 7 | 12 | 1000 |

Device marking

ZXTP19020D







Pinout - top view

Absolute maximum ratings

| Parameter | Symbol | Limit | Unit |
|--|-----------------------------------|------------|-------|
| Collector-Base voltage | V _{CBO} | -25 | V |
| Collector-Emitter voltage | V _{CEO} | -20 | V |
| Emitter-Collector voltage (reverse blocking) | V _{ECO} | -4 | V |
| Emitter-Base voltage | V _{EBO} | -7 | V |
| Continuous Collector current ^(c) | ۱ _C | -8 | А |
| Base current | ا _B | -1 | А |
| Peak pulse current | I _{CM} | -15 | А |
| Power dissipation at $T_A = 25^{\circ}C^{(a)}$ | PD | 1.2 | W |
| Linear derating factor | | 9.6 | mW/°C |
| Power dissipation at $T_A = 25^{\circ}C^{(b)}$ | PD | 1.6 | W |
| Linear derating factor | | 12.8 | mW/°C |
| Power dissipation at $T_A = 25^{\circ}C^{(C)}$ | PD | 3.0 | W |
| Linear derating factor | | 24 | mW/°C |
| Power dissipation at $T_A = 25^{\circ}C^{(d)}$ | PD | 5.3 | W |
| Linear derating factor | | 42 | mW/°C |
| Power dissipation at $T_{C} = 25^{\circ}C^{(e)}$ | PD | 10.2 | W |
| Linear derating factor | | 81 | mW/°C |
| Operating and storage temperature range | T _j , T _{stg} | -55 to 150 | °C |

Thermal resistance

| Parameter | Symbol | Limit | Unit |
|------------------------------------|------------------|-------|------|
| Junction to ambient ^(a) | R _{OJA} | 104 | °C/W |
| Junction to ambient ^(b) | R _{OJA} | 78 | °C/W |
| Junction to ambient ^(c) | R _{OJA} | 42 | °C/W |
| Junction to ambient ^(d) | $R_{\Theta JA}$ | 23.5 | °C/W |
| Junction to case ^(e) | R _{OJC} | 12.3 | °C/W |

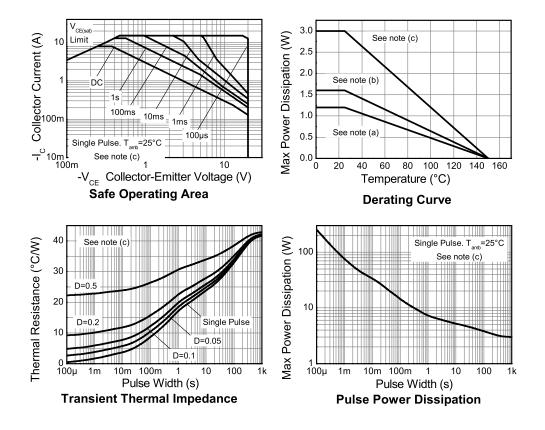
NOTES:

(a) For a device surface mounted on 15mm x 15mm x 0.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.

(b) Mounted on $25mm \times 25mm \times 0.6mm$ FR4 PCB with high coverage of single sided 1oz copper, in still air conditions. (c) Mounted on $50mm \times 50mm \times 0.6mm$ FR4 PCB with high coverage of single sided 2oz copper, in still air conditions. (d) As (c) above measured at t<5 seconds.

(e) Junction to case (collector tab). Typical

Thermal characteristics



| Parameter | Symbol | Min. | Тур. | Max. | Unit | Conditions |
|--|----------------------|------|-------|-------|------|---|
| Collector-Base breakdown voltage | BV _{CBO} | -25 | -55 | | V | I _C = -100μA |
| Collector-Emitter breakdown voltage | BV _{CEO} | -20 | -50 | | V | I _C = -10mA ^(*) |
| Emitter-Collector breakdown voltage (reverse blocking) | BV _{ECX} | -4 | -8.6 | | V | $I_E = -100$ μA, $R_{BC} < 1$ kΩ or 0.25V > V _{BC} > -0.25V |
| Emitter-Collector breakdown voltage (reverse blocking) | BV _{ECO} | -4 | -8.6 | | > | I _E = -100μΑ |
| Emitter-Base breakdown voltage | BV _{EBO} | -7 | -8.2 | | V | I _E = -100μA |
| Collector-Base cut-off | I _{CBO} | | <1 | 50 | nA | V _{CB} = -25V |
| current | | | | 0.5 | μA | V _{CB} = -25V, T _{amb} =100°C |
| Emitter cut-off current | I _{EBO} | | <1 | -50 | nA | V _{EB} = -5.6V |
| Collector-Emitter | V _{CE(sat)} | | -40 | -47 | mV | $I_{\rm C} = -1A$, $I_{\rm B} = -100 {\rm mA}^{(*)}$ |
| saturation voltage | | | -97 | -130 | mV | $I_{\rm C} = -1A$, $I_{\rm B} = -10 {\rm mA}^{(*)}$ |
| | | | -115 | -145 | mV | $I_{C} = -2A, I_{B} = -40mA^{(*)}$ |
| | | | -220 | -275 | mV | $I_{C} = -8A$, $I_{B} = -800 \text{mA}^{(*)}$ |
| Base-Emitter saturation voltage | V _{BE(sat)} | | -1050 | -1150 | mV | $I_{\rm C}$ = -8A, $I_{\rm B}$ = -800mA ^(*) |
| Base-Emitter turn-on voltage | V _{BE(on)} | | -930 | -1000 | mV | $I_{C} = -8A, V_{CE} = -2V^{(*)}$ |
| Static forward current | h _{FE} | 300 | 450 | 900 | | $I_{C} = -100 \text{mA}, V_{CE} = -2V^{(*)}$ |
| transfer ratio | | 200 | 290 | | | $I_{C} = -2A, V_{CE} = -2V^{(*)}$ |
| | | 45 | 70 | | | $I_{C} = -8A, V_{CE} = -2V^{(*)}$ |
| | | | 25 | | | $I_{C} = -15A, V_{CE} = -2V^{(*)}$ |
| Transition frequency | f _T | | 176 | | MHz | I _C = -50mA, V _{CE} = -10V f = 50MHz |
| Input capacitance | C _{ibo} | | | 400 | pF | V _{EB} = -0.5V, f = 1MHz ^(*) |
| Output capacitance | C _{obo} | | 36 | 45 | pF | V _{CB} = -10V, f = 1MHz ^(*) |
| Delay time | t _d | | 23 | | ns | |
| Rise time | t _r | | 18.4 | | ns | $I_{\rm C} = -1A, V_{\rm CC} = -10V,$ |
| Storage time | t _s | | 266 | | ns | I _{B1} = -I _{B2} = -50mA |
| Fall time | t _f | | 49.6 | | ns | |

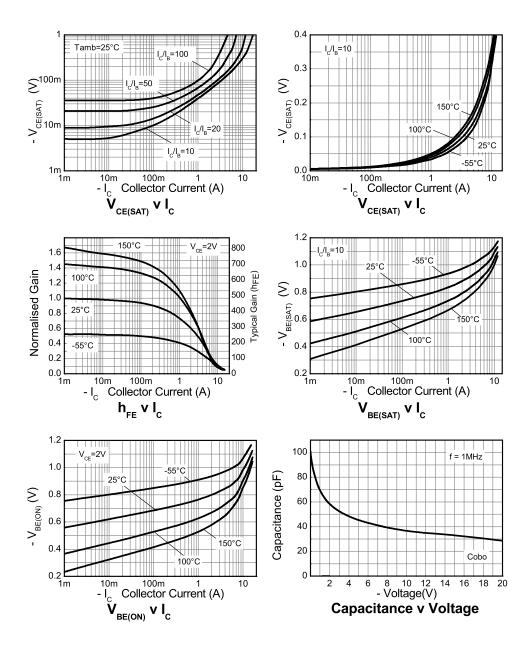
Electrical characteristics (at T_{amb} = 25°C unless otherwise stated)

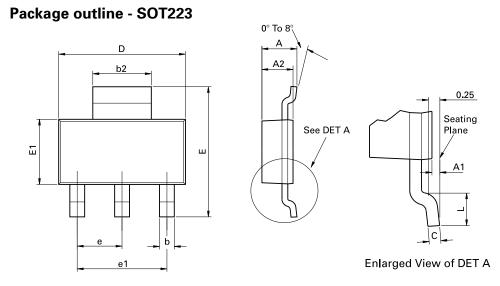
NOTES:

(*) Measured under pulsed conditions. Pulse width \leq 300µs; duty cycle \leq 2%.



Typical characteristics





Conforms to JEDEC TO-261 AA Issue B

| Dim. | Millin | neters | Inc | hes | Dim. | Millimeters | | Inches | |
|-------|--------|--------|--------|--------|------|-------------|------|--------|-------|
| Dini. | Min. | Max. | Min. | Max. | | Min. | Max. | Min. | Max. |
| А | - | 1.80 | - | 0.071 | D | 6.30 | 6.70 | 0.248 | 0.264 |
| A1 | 0.02 | 0.10 | 0.0008 | 0.004 | е | 2.30 | BSC | 0.090 | 5 BSC |
| A2 | 1.55 | 1.65 | 0.0610 | 0.0649 | e1 | 4.60 | BSC | 0.181 | BSC |
| b | 0.66 | 0.84 | 0.026 | 0.033 | E | 6.70 | 7.30 | 0.264 | 0.287 |
| b2 | 2.90 | 3.10 | 0.114 | 0.122 | E1 | 3.30 | 3.70 | 0.130 | 0.146 |
| С | 0.23 | 0.33 | 0.009 | 0.013 | L | 0.90 | - | 0.355 | - |

Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in inches

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|-----------------------------------|--|
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| Europe | Americas | Asia Pacific | Corporate Headquarters |
|---|---|--|--|
| Zetex GmbH Kustermann-park Balanstraße 59 D-81541 München Germanv | Zetex Inc 700 Veterans Memorial Highway Hauppauge, NY 11788 USA | Zetex (Asia Ltd) 3701-04 Metroplaza Tower 1 Hing Fong Road, Kwai Fong Hong Kong | Zetex Semiconductors plc Zetex Technology Park, Chadderton Oldham, OL9 9LL United Kingdom |
| Telefon: (49) 89 45 49 49 0 Fax: (49) 89 45 49 49 49 europe.sales@zetex.com | Telephone: (1) 631 360 2222 Fax: (1) 631 360 8222 usa.sales@zetex.com | Telephone: (852) 26100 611 Fax: (852) 24250 494 asia.sales@zetex.com | Telephone: (44) 161 622 4444 Fax: (44) 161 622 4446 hq@zetex.com |

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